Toshiba Bipolar Digital Integrated Circuit Silicon Monolithic

TD62081APG,TD62081AFG,TD62082APG,TD62082AFG,TD62083APG,TD62083AFG,TD62084APG,TD62084AFG

8ch Darlington Sink Driver

The TD62081APG/AFG Series are high-voltage, high-current darlington drivers comprised of eight NP darlington pairs. All units feature integral clamp diodes for switching inductive loads. Applications include relay, hammer, lamp and display (LED) drivers.

The suffix (G) appended to the part number represents a Lead (Pb)-Free product.

Features

- Output current (single output) 500 mA (max) (TD62081APG/AFG series)
- High sustaining voltage output
 V (min) (TD62081APG/AFG series)
- Output clamp diodes
- Inputs compatible with various types of logic.
- Package type-APG: DIP-18 pin
- Package type-AFG: SOP-18 pin

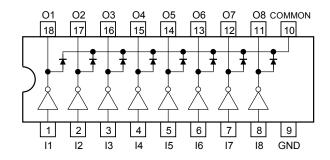
Туре	Input Base Resistor	Designation
TD62081APG/AFG	External	General purpose
TD62082APG/AFG	$\begin{array}{c} 10.5\text{-k}\Omega+7~\text{V}\\ \text{Zenner diode} \end{array}$	14 V to 25 V PMOS
TD62083APG/AFG	2.7 kΩ	TTL, 5 V CMOS
TD62084APG/AFG	10.5 kΩ	6 V to 15 V PMOS, CMOS

TD62081APG, TD62082APG TD62083APG, TD62084APG DIP18-P-300-2.54D TD62081AFG, TD62082AFG TD62083AFG, TD62084AFG SOP18-P-375-1.27

Weight

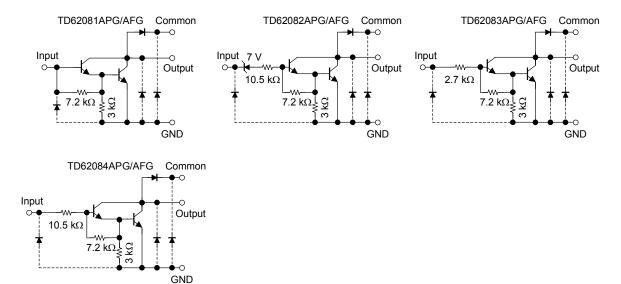
DIP18-P-300-2.54D: 1.47 g (typ.) SOP18-P-375-1.27: 0.41 g (typ.)

Pin Connection (top view)





Schematics (each driver)



Note: The input and output parasitic diodes cannot be used as clamp diodes.

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Output sustaining voltage		V _{CE} (SUS)	-0.5 to 50	V	
Output current		I _{OUT}	500	mA/ch	
Input voltage		V _{IN} (Note 1)	-0.5 to 30	V	
Input current		I _{IN} (Note 2)	25	mA	
Clamp diode reverse voltage		V _R	50	V	
Clamp diode forward current		ΙF	500	mA	
Power dissipation	APG	PD	1.47	W	
Power dissipation	AFG	רט	0.96	VV	
Operating temperature		T _{opr}	-40 to 85	°C	
Storage temperature		T _{stg}	-55 to 150	°C	

Note 1: Except TD62081APG/AFG Note 2: Only TD62081APG/AFG



Recommended Operating Conditions ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Cha	racteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output sustainin	g voltage	V _{CE (SUS)}		0	_	50	V
Output current	APG	Гоит	T _{pw} = 25 ms, Duty = 10% 8 circuits	0	_	347	- mA/ch
			T _{pw} = 25 ms, Duty = 50% 8 circuits	0	_	123	
	AFG		T _{pw} = 25 ms, Duty = 10% 8 circuits	0	_	268	
	AFG		T _{pw} = 25 ms, Duty = 50% 8 circuits	0	_	90	
Input voltage	Except TD62081APG/AFG	V _{IN}		0	_	30	V
Input voltage (Output on)	TD62082APG/AFG			14		30	٧
	TD62083APG/AFG	V _{IN (ON)}		2.5	_	30	
(Gatpat G.)	TD62084APG/AFG			8	_	30	
	TD62082APG/AFG	V _{IN (OFF)}		0	_	7.4	
Input voltage (Output off)	TD62083APG/AFG			0	_	0.5	V
(TD62084APG/AFG			0	_	1.0	
Input current	Only TD62081APG/AFG	I _{IN}		0	_	5	mA
Clamp diode reverse voltage		V _R		_	_	50	V
Clamp diode forward current		l _F		_	_	400	mA
Power dissipation	APG	Б		_	_	0.52	10/
	AFG	P_{D}		_	_	0.4	W



Electrical Characteristics (Ta = 25°C)

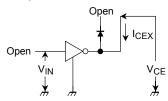
Cha	racteristics	Symbol	Test Circuit	Test Condition		Min	Тур.	Max	Unit
			1	V _{CE} = 50 V	Ta = 25°C	_	_	50	μΑ
Output leakage current		1			Ta = 85°C	_	_	100	
	TD62082	I _{CEX}			V _{IN} = 6 V	_	_	500	
	TD62084				V _{IN} = 1 V		_	500	
				$I_{OUT} = 350 \text{ mA}, I_{IN} = 500 \mu\text{A}$		_	1.3	1.6	٧
Collector-emitter saturation voltage		V _{CE (sat)}	2	I _{OUT} = 200 mA, I _{IN}	_I = 350 μA	_	1.1	1.3	
	-			I _{OUT} = 100 mA, I _{IN}	_I = 250 μA	_	0.9	1.1	
	TD62082APG/AFG			V _{IN} = 17 V	_ 0.82		1.25		
	TD62083APG/AFG			V _{IN} = 3.85 V		_	0.93	1.35	mA
Input current	TD000044D0/4F0	I _{IN} (ON)	2	V _{IN} = 5 V		_	0.35	0.5	
	TD62084APG/AFG			V _{IN} = 12 V		_	1.0	1.45	
	I _{IN (OFF)} 4 I _{OUT} = 500 μA, Ta = 85°C		= 85°C	50	65	_	μА		
	TD62082APG/AFG	V _{IN (ON)}		V _{CE} = 2 V, I _{OUT} = 300 mA			_	13	V
	TD62083APG/AFG		5	V _{CE} = 2 V, I _{OUT} = 200 mA			_	2.4	
				V _{CE} = 2 V, I _{OUT} = 250 mA		_	_	2.7	
Input voltage				V _{CE} = 2 V, I _{OUT} = 300 mA		_	_	3.0	
(Output on)	TD62084APG/AFG			V _{CE} = 2 V, I _{OUT} = 125 mA		_	_	5.0	
				V _{CE} = 2 V, I _{OUT} = 200 mA		_	_	6.0	
				V _{CE} = 2 V, I _{OUT} = 275 mA		_	_	7.0	
				V _{CE} = 2 V, I _{OUT} = 350 mA			_	8.0	
DC current transfer ratio		h _{FE}	2	V _{CE} = 2 V, I _{OUT} =	350 mA	1000	_	_	
Clamp diads	voran aurrant	1-		Ta = 25°C	(Note)	_	_	50	
Clamp diode reverse current		I _R	6	Ta = 85°C	(Note)	_	_	100	μА
Clamp diode forward voltage		V _F	7	I _F = 350 mA		_	_	2.0	V
Input capacitano	t capacitance C _{IN} —			_	15	_	pF		
Turn-on delay		t _{ON} 8		$R_L = 125 \Omega, V_{OUT}$	= 50 V	_	0.1	_	
Turn-off delay				R _L = 125 Ω, V _{OUT} = 50 V		_	0.2	_	μS

4

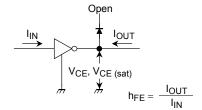
Note: $V_R = V_R \text{ max}$

Test Circuit

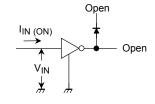
1. I_{CEX}



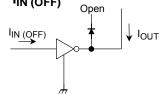
2. V_{CE (sat)}, h_{FE}



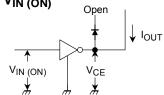
3. I_{IN (ON)}



4. I_{IN (OFF)}

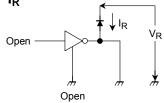


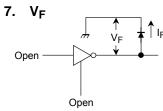
5. V_{IN (ON)}



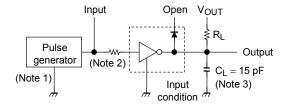
5

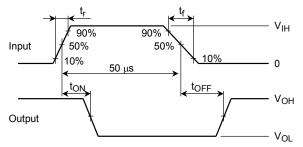
6. I_R





8. ton, toff





Note 1: Pulse width 50 µs, duty cycle 10%

Output impedance 50 Ω , $t_r \le 5$ ns, $t_f \le 10$ ns

Note 2: See below.

Input condition

Type Number	R1	V _{IH}
TD62081APG/AFG	2.7 kΩ	3 V
TD62082APG/AFG	0 Ω	13 V
TD62083APG/AFG	0 Ω	3 V
TD62084APG/AFG	0 Ω	8 V

Note 3: C_L includes probe and jig capacitance

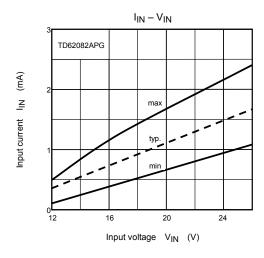
Precautions for Using

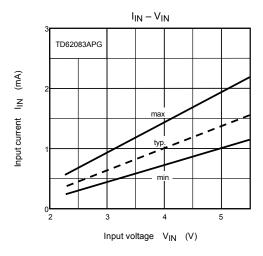
This IC does not include built-in protection circuits for excess current or overvoltage.

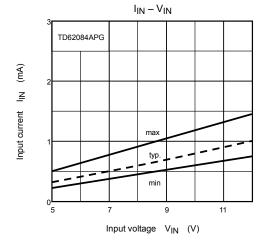
If this IC is subjected to excess current or overvoltage, it may be destroyed.

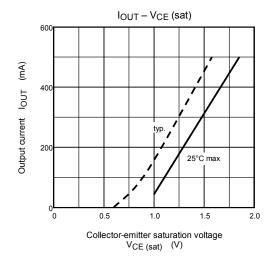
Hence, the utmost care must be taken when systems which incorporate this IC are designed.

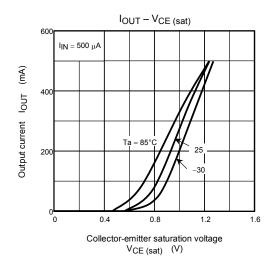
Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

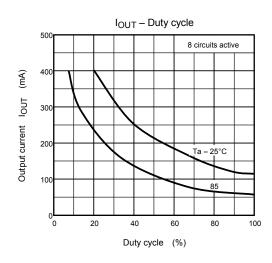


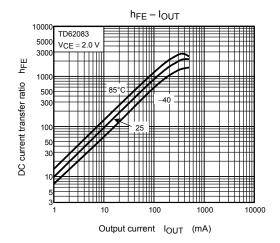


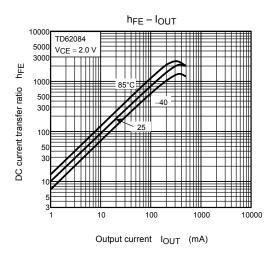


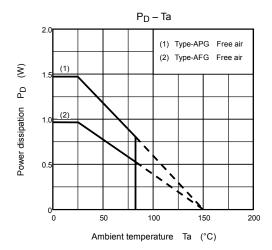








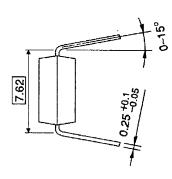




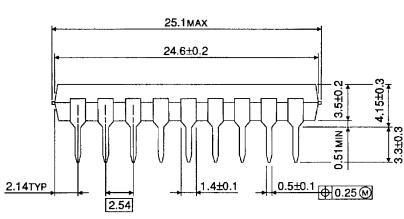
Unit: mm

Package Dimensions

DIP18-P-300-2.54D

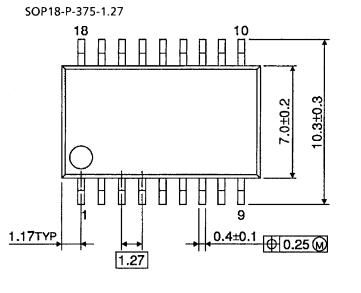


6.4±0.2

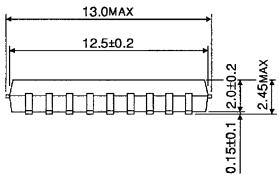


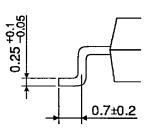
Weight: 1.47 g (typ.)

Package Dimensions



Unit : mm





Weight: 0.41 g (typ.)

Notes on Contents

1. Schematics

The schematics may be simplified or some parts of them may be omitted for explanatory purposes.

2. Absolute Maximum Ratings

The absolute maximum ratings of a semiconductor device are a set of specified parameter values that must not be exceeded during operation, even for an instant.

If any of these ratings are exceeded during operation, the electrical characteristics of the device may be irreparably altered and the reliability and lifetime of the device can no longer be guaranteed.

Moreover, any exceeding of the ratings during operation may cause breakdown, damage and/or degradation in other equipment. Applications using the device should be designed so that no absolute maximum rating will ever be exceeded under any operating conditions.

Before using, creating and/or producing designs, refer to and comply with the precautions and conditions set forth in this document.

3. Recommended Operating Conditions

The values of the conditions are applied within the range of the operating temperature and not guaranteed.

4. AC Characteristics

AC characteristics that mean turn-on and turn-off time are targeted design values and not guaranteed.

5. Application Circuits

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially in the phase of mass production design.

In furnishing these examples of application circuits, Toshiba does not grant the use of any industrial property rights.

6. Graphics Characteristics

Graphics characteristics are reference ones and not guaranteed.

Handling of the IC

Ensure that the product is installed correctly to prevent breakdown, damage and/or degradation in the product or equipment.

About solderability, following conditions were confirmed

- Solderability
 - (1) Use of Sn-37Pb solder Bath
 - · solder bath temperature = 230°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux
 - (2) Use of Sn-3.0Ag-0.5Cu solder Bath
 - · solder bath temperature = 245°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux

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 in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such
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 - In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc. 021023_A
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